



STGW30NC60VD

N-channel 40A - 600V - TO-247
Very fast switching PowerMESH™ IGBT

General features

| Type | V _{CES} | V _{CE(sat)} (Max)@ 25°C | I _C @100°C |
|--------------|------------------|-------------------------------------|--------------------------|
| STGW30NC60VD | 600V | <2.5V | 40A |

- High current capability
- High frequency operation up to 50KHz
- Very soft ultra fast recovery antiparallel diode
- New generation products with tighter parameter distribution

Description

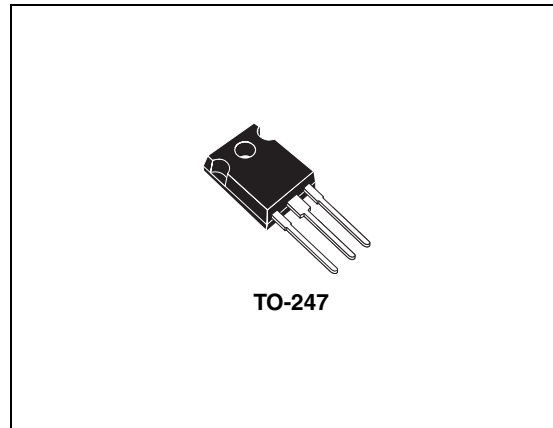
Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The suffix “V” identifies a family optimized for high frequency.

Applications

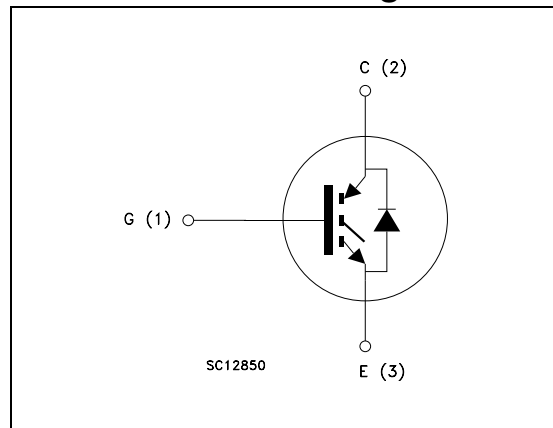
- High frequency inverters, UPS
- Motor drivers
- SMPS and PFC in both hard switch and resonant topologies

Order code

| Part number | Marking | Package | Packaging |
|--------------|------------|---------|-----------|
| STGW30NC60VD | GW30NC60VD | TO-247 | Tube |



Internal schematic diagram



1 Electrical ratings

Table 1. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|----------------|---|-------------|------|
| V_{CES} | Collector-emitter voltage ($V_{GS} = 0$) | 600 | V |
| $I_C^{(1)}$ | Collector current (continuous) at 25°C | 80 | A |
| $I_C^{(1)}$ | Collector current (continuous) at 100°C | 40 | A |
| $I_{CM}^{(2)}$ | Collector current (pulsed) | 100 | A |
| I_{CL} | Turn-off soa minimum current | 100 | A |
| V_{GE} | Gate-emitter voltage | ± 20 | V |
| I_F | Diode RMS forward current at $T_C=25^\circ\text{C}$ | 30 | A |
| P_{TOT} | Total dissipation at $T_C = 25^\circ\text{C}$ | 250 | W |
| T_j | Operating junction temperature | - 55 to 150 | °C |
| T_{stg} | Storage temperature | | |

1. Calculated according to the iterative formula:

$$I_C(T_C) = \frac{T_{JMAX} - T_C}{R_{THJ-C} \times V_{CESAT(MAX)}(T_C, I_C)}$$

2. Pulse width limited by max junction temperature

Table 2. Thermal resistance

| Symbol | Parameter | Min. | Typ. | Max. | Unit |
|-----------|--|------|------|------|------|
| Rthj-case | Thermal resistance junction-case IGBT | | | 0.48 | °C/W |
| | Thermal resistance junction-case diode | | | 1.5 | °C/W |
| Rthj-amb | Thermal resistance junction-ambient | | | 62.5 | °C/W |

2 Electrical characteristics

($T_{CASE}=25^{\circ}C$ unless otherwise specified)

Table 3. Static

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|--|---|------|------------|-----------|---------------------|
| $V_{BR(CES)}$ | Collector-emitter breakdown voltage | $I_C = 1\text{mA}, V_{GE} = 0$ | 600 | | | V |
| $V_{CE(SAT)}$ | Collector-emitter saturation voltage | $V_{GE}=15\text{V}, I_C=20\text{A}, T_j=25^{\circ}C$ $V_{GE}=15\text{V}, I_C=20\text{A}, T_j=125^{\circ}C$ | | 1.8 1.7 | 2.5 | V V |
| $V_{GE(th)}$ | Gate threshold voltage | $V_{CE}=V_{GE}, I_C=250\mu\text{A}$ | 3.75 | | 5.75 | V |
| I_{CES} | Collector-emitter leakage current ($V_{GE} = 0$) | $V_{CE} = \text{Max rating}, T_c=25^{\circ}C$ $V_{CE} = \text{Max rating}, T_c=125^{\circ}C$ | | | 250 1 | μA mA |
| I_{GES} | Gate-emitter leakage current ($V_{CE} = 0$) | $V_{GE} = \pm 20\text{V}, V_{CE} = 0$ | | | ± 100 | nA |
| g_{fs} | Forward transconductance | $V_{CE} = 15\text{V}, I_C = 20\text{A}$ | | 15 | | S |

Table 4. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max | Unit |
|-----------|------------------------------|---|------|------|-----|------|
| C_{ies} | Input capacitance | $V_{CE} = 25\text{V}, f = 1\text{MHz}, V_{GE} = 0$ | | 2200 | | pF |
| C_{oes} | Output capacitance | | | 225 | | pF |
| C_{res} | Reverse transfer capacitance | | | 50 | | pF |
| Q_g | Total gate charge | $V_{CE} = 390\text{V}, I_C = 20\text{A},$ $V_{GE} = 15\text{V},$ <i>(see Figure 17)</i> | | 100 | 140 | nC |
| Q_{ge} | Gate-emitter charge | | | 16 | | nC |
| Q_{gc} | Gate-collector charge | | | 45 | | nC |

Table 5. Switching on/off (inductive load)

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------|-----------------------|---|------|------|------|------------------|
| $t_{d(on)}$ | Turn-on delay time | $V_{CC}=390\text{ V}$, $I_C=20\text{ A}$, | | 31 | | ns |
| t_r | Current rise time | $R_G=3.3\Omega$, $V_{GE}=15\text{ V}$ | | 11 | | ns |
| $(di/dt)_{onf}$ | Turn-on current slope | $T_j=25^\circ\text{C}$ (see Figure 16) | | 1600 | | A/ μs |
| $t_{d(on)}$ | Turn-on delay time | $V_{CC}=390\text{ V}$, $I_C=20\text{ A}$, | | 31 | | ns |
| t_r | Current rise time | $R_G=3.3\Omega$, $V_{GE}=15\text{ V}$ | | 11.5 | | ns |
| $(di/dt)_{on}$ | Turn-on current slope | $T_j=125^\circ\text{C}$ (see Figure 16) | | 1500 | | A/ μs |
| $t_{r(Voff)}$ | Off voltage rise time | $V_{CC}=390\text{ V}$, $I_C=20\text{ A}$, | | 28 | | ns |
| $t_{d(off)}$ | Turn-off delay time | $R_G=3.3\Omega$, $V_{GE}=15\text{ V}$ | | 100 | | ns |
| t_f | Current fall time | $T_j=25^\circ\text{C}$ (see Figure 16) | | 75 | | ns |
| $t_{r(Voff)}$ | Off voltage rise time | $V_{CC}=390\text{ V}$, $I_C=20\text{ A}$, | | 66 | | ns |
| $t_{d(off)}$ | Turn-off delay time | $R_G=3.3\Omega$, $V_{GE}=15\text{ V}$ | | 150 | | ns |
| t_f | Current fall time | $T_j=125^\circ\text{C}$ (see Figure 16) | | 130 | | ns |

Table 6. Switching energy (inductive load)

| Symbol | Parameter | Test conditions | Min | Typ. | Max | Unit |
|----------------|---------------------------|---|-----|------|-----|---------------|
| $E_{on}^{(1)}$ | Turn-on switching losses | $V_{CC}=390\text{ V}$, $I_C=20\text{ A}$, | | 220 | 300 | μJ |
| E_{off} | Turn-off switching losses | $R_G=3.3\Omega$, $V_{GE}=15\text{ V}$, | | 330 | 450 | μJ |
| E_{ts} | Total switching losses | $T_j=25^\circ\text{C}$ (see Figure 18) | | 550 | 750 | μJ |
| $E_{on}^{(1)}$ | Turn-on switching losses | $V_{CC}=390\text{ V}$, $I_C=20\text{ A}$, | | 450 | | μJ |
| E_{off} | Turn-off switching losses | $R_G=3.3\Omega$, $V_{GE}=15\text{ V}$, | | 770 | | μJ |
| E_{ts} | Total switching losses | $T_j=125^\circ\text{C}$ (see Figure 18) | | 1220 | | μJ |

1. E_{on} is the turn-on losses when a typical diode is used in the test circuit in Figure 18. E_{on} include diode recovery energy. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

Table 7. Collector-emitter diode

| Symbol | Parameter | Test conditions | Min | Typ. | Max | Unit |
|-----------|--------------------------|--|-----|----------|-----|--------|
| V_f | Forward on-voltage | $I_f=10\text{ A}$ $I_f=10\text{ A}$, $T_j=125^\circ\text{C}$ | | 1.3 1 | 2.0 | V V |
| t_{rr} | Reverse recovery time | $I_f=20\text{ A}$, $V_R=40\text{ V}$, | | 44 | | ns |
| Q_{rr} | Reverse recovery charge | $T_j=25^\circ\text{C}$, $di/dt=100\text{ A}/\mu\text{s}$ | | 66 | | nC |
| I_{rrm} | Reverse recovery current | (see Figure 19) | | 3 | | A |
| t_{rr} | Reverse recovery time | $I_f=20\text{ A}$, $V_R=40\text{ V}$, | | 88 | | ns |
| Q_{rr} | Reverse recovery charge | $T_j=125^\circ\text{C}$, | | 237 | | nC |
| I_{rrm} | Reverse recovery current | $di/dt=100\text{ A}/\mu\text{s}$ (see Figure 19) | | 5.4 | | A |

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark.

TO-247 MECHANICAL DATA

| DIM. | mm. | | | inch | | |
|------|-------|-------|-------|-------|-------|-------|
| | MIN. | TYP | MAX. | MIN. | TYP. | MAX. |
| A | 4.90 | | 5.16 | 0.193 | | 0.203 |
| D | 2.35 | | 2.45 | 0.093 | | 0.096 |
| E | 0.6 | | 0.76 | 0.024 | | 0.030 |
| F | 1.2 | | 1.33 | 0.047 | | 0.052 |
| F1 | | 3 | | | 0.118 | |
| F2 | | 2 | | | 0.078 | |
| F3 | 1.9 | | 2.13 | 0.075 | | 0.084 |
| F4 | 3.04 | | 3.2 | 0.120 | | 0.126 |
| G | | 10.90 | | | 0.429 | |
| H | 15.77 | | 16.03 | 0.621 | | 0.631 |
| L | 20.83 | | 21.09 | 0.820 | | 0.830 |
| L1 | 3.93 | | 4.45 | 0.155 | | 0.175 |
| L2 | 18.72 | | 19.18 | 0.737 | | 0.755 |
| L3 | 20.04 | | 20.31 | 0.789 | | 0.800 |
| L4 | 40.88 | | 41.40 | 1.609 | | 1.630 |
| L5 | 6.04 | | 6.30 | 0.238 | | 0.248 |
| M | 2 | | 3 | | 0.078 | 0.118 |
| V | | 5° | | | 5° | |
| V2 | | 60° | | | 60° | |
| Diam | 3.56 | | 3.66 | 0.140 | | 0.144 |

